



DGTD120T25S1PT

1200V FIELD STOP IGBT IN TO-247

Description

The DGTD120T25S1PT is produced using advanced Field Stop Trench IGBT Technology, which provides low $V_{CE(sat)}$, excellent quality and high-switching performance.

Features

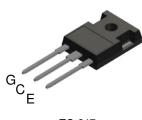
- High Speed Switching & Low V_{CE(sat)} Loss
- $V_{CE(sat)} = 2.0V @ I_C = 25A$
- High Input Impedance
- t_{rr} = 100ns (typ) @ di_F/dt = 500A/µs
- Ultra-Soft, Fast Recovery Anti-parallel Diode
- Ultra Narrowed VF Distribution Control
- Positive Temperature Coefficient For Easy Parallelling
- Maximum Junction Temperature 175°C
- Lead-Free Finish & RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Applications

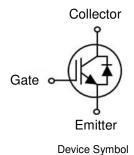
- Motor Drive
- UPS
- Welder
- Solar Inverter
- IH Cooker

Mechanical Data

- Case: TO-247 (Type MC)
- Case Material: Molded Plastic. "Green" Molding Compound.
- UL Flammability Classification Rating 94V-0
- Terminals: Finish Matte Tin Plated Leads. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 5.6 grams (Approximate)



TO-247



Ordering Information (Note 4)

	Product	Marking	Quantity				
	DGTD120T25S1PT	DGTD120T25S1	450 per Box in Tubes (Note 5)				
Notes:	1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.						

EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

5. 30 Devices per Tube.

Marking Information



);; = Manufacturer's Marking DGTD120T25S1 = Product Type Marking Code YY = Year (ex: 18 = 2018) LLLLL = Lot Code WW = Week (01 to 53)



Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Collector-Emitter Voltage	ctor-Emitter Voltage		1,200	V	
DC Collector Current limited by T	$T_{\rm C} = 25^{\circ}{\rm C}$		50	А	
DC Collector Current, limited by T_{vjmax}	$T_{\rm C} = 100^{\circ}{\rm C}$	IC	25	А	
Pulsed Collector Current, tp limited by Tvimax		I _{Cpuls}	100	А	
Turn Off Safe Operating Area V _{CE} ≤ 1200V, T _{vi}	= 175°C	-	100	А	
Diada Famuand Compare limited by T	$T_C = 25^{\circ}C$		25	А	
Diode Forward Current limited by T _{vjmax}	$T_{C} = 100^{\circ}C$	IF	12.5	А	
Diode Pulsed Current, tp limited by Tvimax		I _{Fpuls}	100	А	
Gate-Emitter Voltage		V _{GE}	±20	V	
Short Circuit Withstand Time					
$V_{CC} \le 600V$, $V_{GE} = 15V$, $T_{vj} = 175^{\circ}C$ Allowed Number of Short Circuits < 1000		tsc	10	μs	
		130			
Time Between Short Circuits ≥ 1.0s					

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbo	I Value	Unit
Power Dissipation Linear Derating Factor (Note 6)	c = 25°C	348	W
Fower Dissipation Linear Derating Factor (Note 8)	P_D	174	٧V
Thermal Resistance, Junction to Ambient (Note 6)	R _{0JA}	40	
Thermal Resistance, Junction to Case for IBGT (Note 6	δ) R _{θJC}	0.43	°C/W
Thermal Resistance, Junction to Case for Diode (Note	6) R _{0JC}	1.55	
Operating Temperature	T _{vi}	-40 to +175	0°
Storage Temperature Range	T _{STG}	-55 to +150	

Note: 6. When mounted on a standard JEDEC 2-layer FR-4 board.

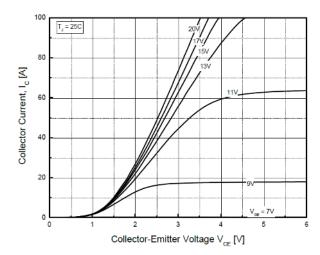


Electrical Characteristics (@T_{vj} = +25°C, unless otherwise specified.)

Parameter		Symbol	Min	Тур	Max	Unit	Condition	
STATIC CHARACTERISTICS								
Collector-Emitter Breakdown Voltage	BV _{CES}	1200	_	_	V	$I_{C} = 500 \mu A, V_{GE} = 0 V$		
	T _{vj} = 25°C		-	2.00	2.40	V		
Collector-Emitter Saturation Voltage	T _{vi} = 150°C	V _{CE(sat)}	_	2.40	_		I _C = 25A, V _{GE} = 15V	
Ĵ	T _{vi} = 175°C	UL(Sat)	_	2.50	-			
Diada Farmand Maltana	$T_{vj} = 25^{\circ}C$	- V _F -	-	2.10	2.60	v	$V_{GE} = 0V, I_F = 12.5A$	
Diode Forward Voltage	T _{vj} = 175°C		_	1.90	-			
	T _{vi} = 25°C	VF	_	2.50	3.00	v		
Diode Forward Voltage	T _{vj} = 150°C		_	2.55	-		$V_{GE} = 0V, I_{F} = 25A$	
_	T _{vj} = 175°C		_	2.45	-			
Gate-Emitter Threshold Voltage		V _{GE(th)}	5.0	6.0	7.0	V	$V_{CE} = V_{GE}, I_{C} = 0.85 \text{mA}$	
	$T_{vj} = 25^{\circ}C$		-	-	250	μA		
Zero Gate Voltage Collector Current	T _{vj} = 175°C	ICES	_	_	2500		$V_{CE} = 1200V, V_{GE} = 0V$	
Gate-Emitter Leakage Current		I _{GES}	_	_	±250	nA	$V_{GE} = 20V, V_{CE} = 0V$	
Transconductance		g fs	_	16	_	S	V _{CE} = 20V, I _C = 25A	
DYNAMIC CHARACTERISTICS							·	
Total Gate Charge		Qg	-	204	-		V 000V I 05A	
Gate-Emitter Charge		Q _{ge}	-	34	-	nC	$V_{CE} = 960V, I_C = 25A, V_{GE} = 15V$	
Gate-Collector Charge		Q _{gc}	-	94	-		VGE = 15V	
Input Capacitance		Cies	-	3942	-			
Reverse Transfer Capacitance		Cres	-	72	-	pF	V _{CE} = 25V, V _{GE} = 0V, f = 1MHz	
Output Capacitance	Output Capacitance		-	142	-	l		
Internal Emitter Inductance Measured 5mm (0.197") From Case		LE	-	13	-	nH	-	
Short Circuit Collector Current Max. 1000 Short Circuits. Time Between Short Circuits ≥ 1.0s		I _{C(SC)}	_	121	_	А	$\label{eq:VGE} \begin{array}{l} V_{GE} = 15V, V_{CC} = 600V, \\ t_{SC} \leq 10 \mu s, T_{vj} = 175^\circ C \end{array}$	
SWITCHING CHARACTERISTICS				70		1		
Turn-on Delay Time		t _{d(on)}	-	73	-	ns mJ		
Rise time		tr	-	41	-		V _{GE} = 15V, V _{CC} = 600V,	
Turn-off Delay Time		t _{d(off)}	-	269	-		$I_{\rm C} = 25A, R_{\rm G} = 23\Omega,$	
Fall Time		t _f	-	39	-		Inductive Load,	
Turn-on Switching Energy		Eon	-	1.44	-		$T_{vj} = 25^{\circ}C$	
Turn-off Switching Energy		E _{off}	-	0.55	-			
Total Switching Energy		Ets	-	1.99	-			
Reverse Recovery Time		t _{rr}	-	100	-	ns	I _F = 25A, di _F /dt = 500A/μs,	
Reverse Recovery Current		I _{rr} Q _{rr}	-	17	-	A	$V_{\rm R} = 600 V_{\rm r}$	
	Reverse Recovery Charge		-	0.85	-	μC	- T _{vi} = 25°C	
Rate Of Fall Of Reverse Current During tb		di _{rr} /dt	-	-376	-	A/μs		
Turn-on Delay Time		t _{d(on)}	-	65	-	-		
Rise time		t _r	-	45	-	ns	$V_{GE} = 15V, V_{CC} = 600V,$	
Turn-off Delay Time		t _{d(off)}	-	292	-	-	$I_{\rm C} = 25$ A, $R_{\rm G} = 23\Omega$,	
Fall Time		t _f	-	75	-		- Inductive Load,	
Turn-on Switching Energy		Eon	-	2.43	-		T _{vj} = 175°C	
Turn-off Switching Energy		E _{off}	-	1.09	-	mJ		
Total Switching Energy	E _{ts}	-	3.52	-				
Reverse Recovery Time		t _{rr}	-	150	-	ns	I _F = 25A, di _F /dt = 500A/μs,	
Reverse Recovery Current		l _{rr}	-	25	-	A	$-V_{\rm R} = 600V,$	
Reverse Recovery Charge		Qrr	-	1.85	-	μΟ	– T _{vi} = 175°C	
Rate Of Fall Of Reverse Current During tb		di _{rr} /dt	-	-374	_	A/µs	-	



Typical Performance Characteristics (@T_A = +25°C, unless otherwise specified.)





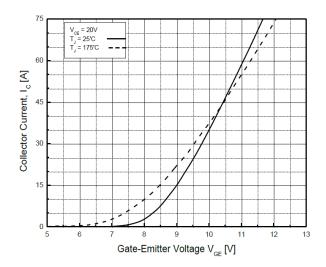


Fig.3 Typical Transfer Characteristic

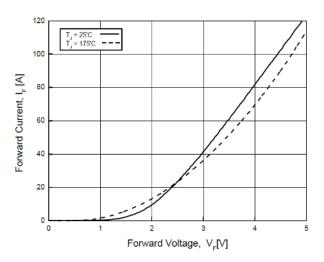


Fig.5 Diode Forward Characteristic

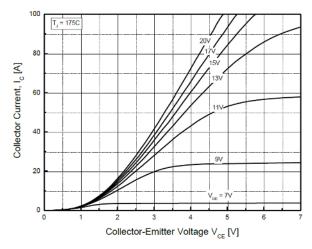


Fig.2 Typical Output Characteristic(T_J=175°C)

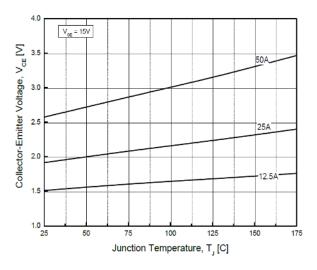


Fig.4 Typical Collector-Emitter Saturation Voltage -Junction Temperature

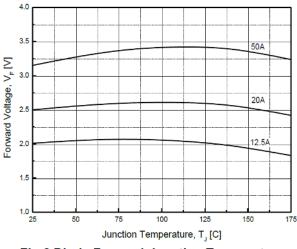


Fig.6 Diode Forward-Junction Temperature



Typical Performance Characteristics (continued)

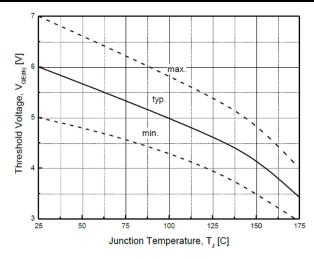
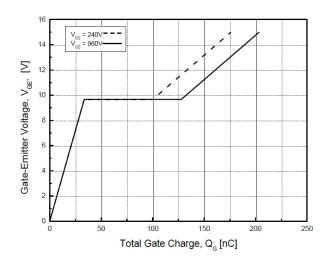
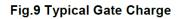


Fig.7 Threshold Voltage-Junction Temperature





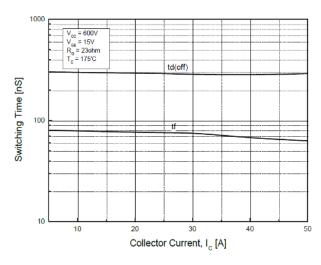


Fig.11 Typical Turn off-Collector Current

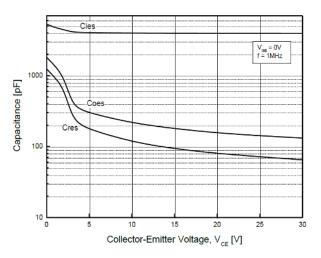


Fig.8 Typical Capacitance

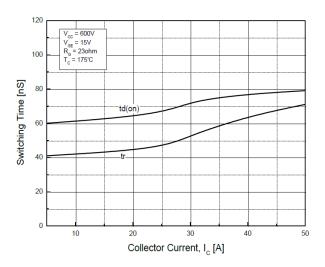
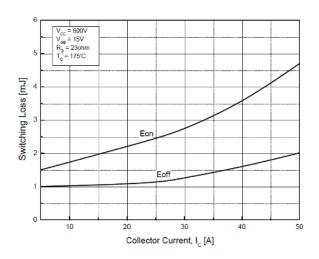
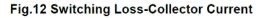


Fig.10 Typical Turn on-Collector Current







Typical Performance Characteristics (cont.)

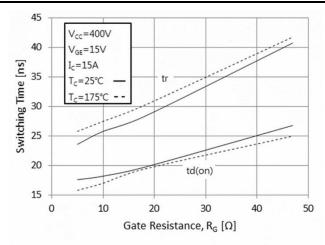


Fig.13 Turn on Characteristics-Gate Resistance

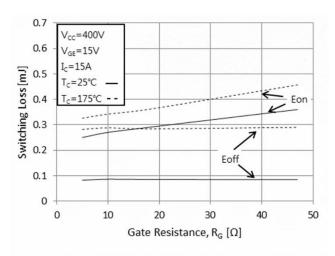


Fig.15 Switching Loss-Gate Resistance

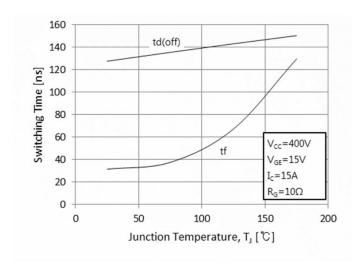


Fig.17 Turn off Characteristics-Junction Temperature

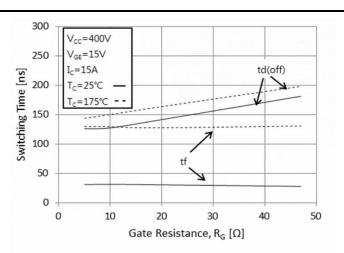


Fig.14 Turn off Characteristics-Gate Resistance

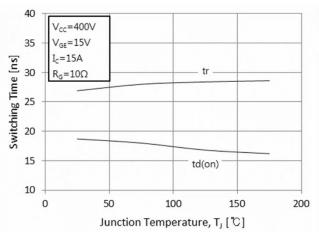
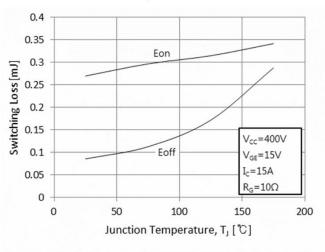
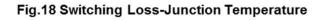


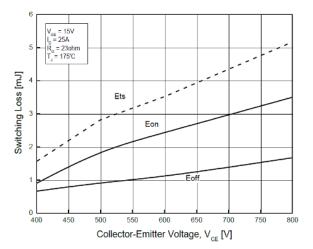
Fig.16 Turn on Characteristics-Junction Temperature







Typical Performance Characteristics (cont.)





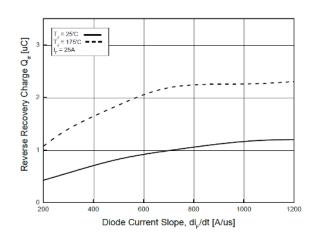


Fig.21 Reverse Recovery Charge -Diode Current Slope

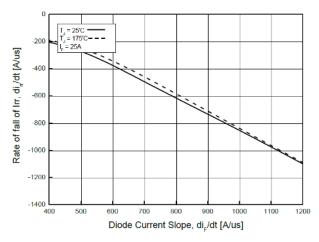


Fig.23 Rate of fall of reverse recovery current -Diode Current Slope

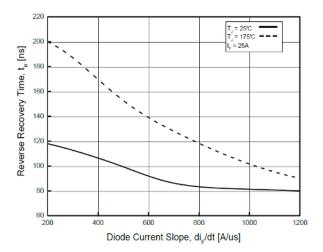


Fig.20 Reverse Recovery Time -Diode current slope

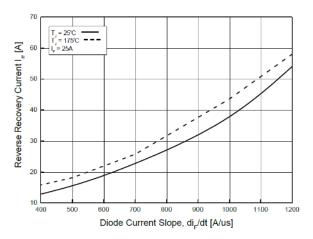


Fig.22 Reverse Recovery Current -Diode current slope

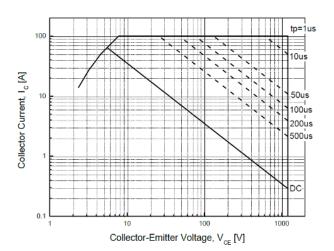


Fig.24 Forward Bias Safe Operating Area



Typical Performance Characteristics (cont.)

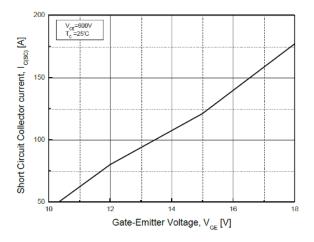


Fig.25 Typical Short Circuit Collector Current

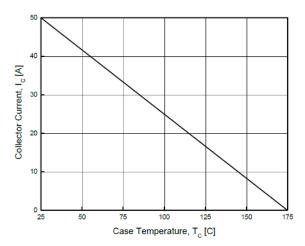


Fig.27 Case Temperature-Collector Current

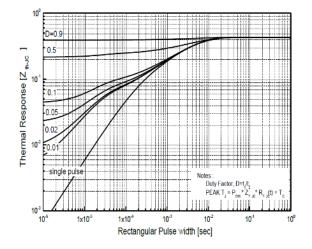


Fig.29 IGBT Transient Thermal Impedance

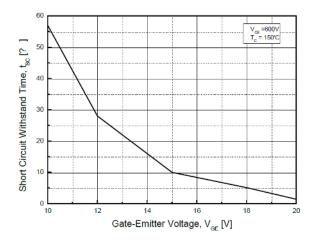


Fig.26 Typical Short Circuit Withstand Time

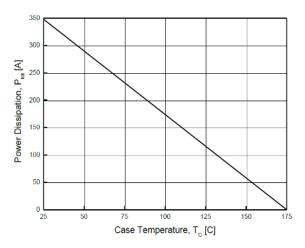


Fig.28 Power Dissipation-Case Temperature

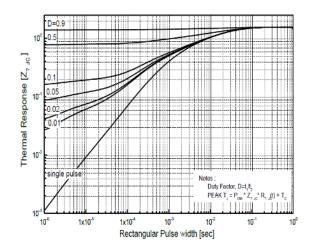
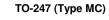


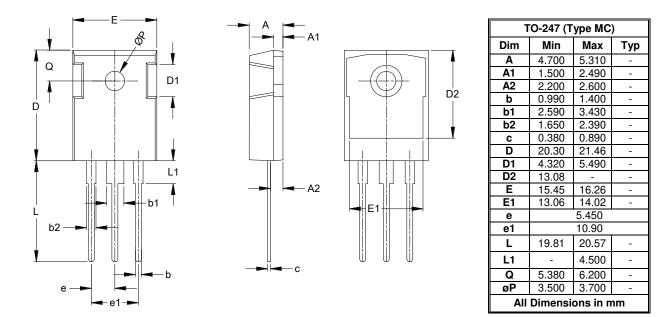
Fig.30 FRD Transient Thermal Impedance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.





Note : For high voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance distances between device Terminals and PCB tracking.



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